



# IPC-2581 CONSORTIUM

For an open neutral global standard for efficient PCB design data transfer

## Design Data Transfer using IPC-2581

Hemant Shah, Chair IPC-2581 Consortium

Ed Acheson, Technical Committee Chair IPC-2581 Consortium

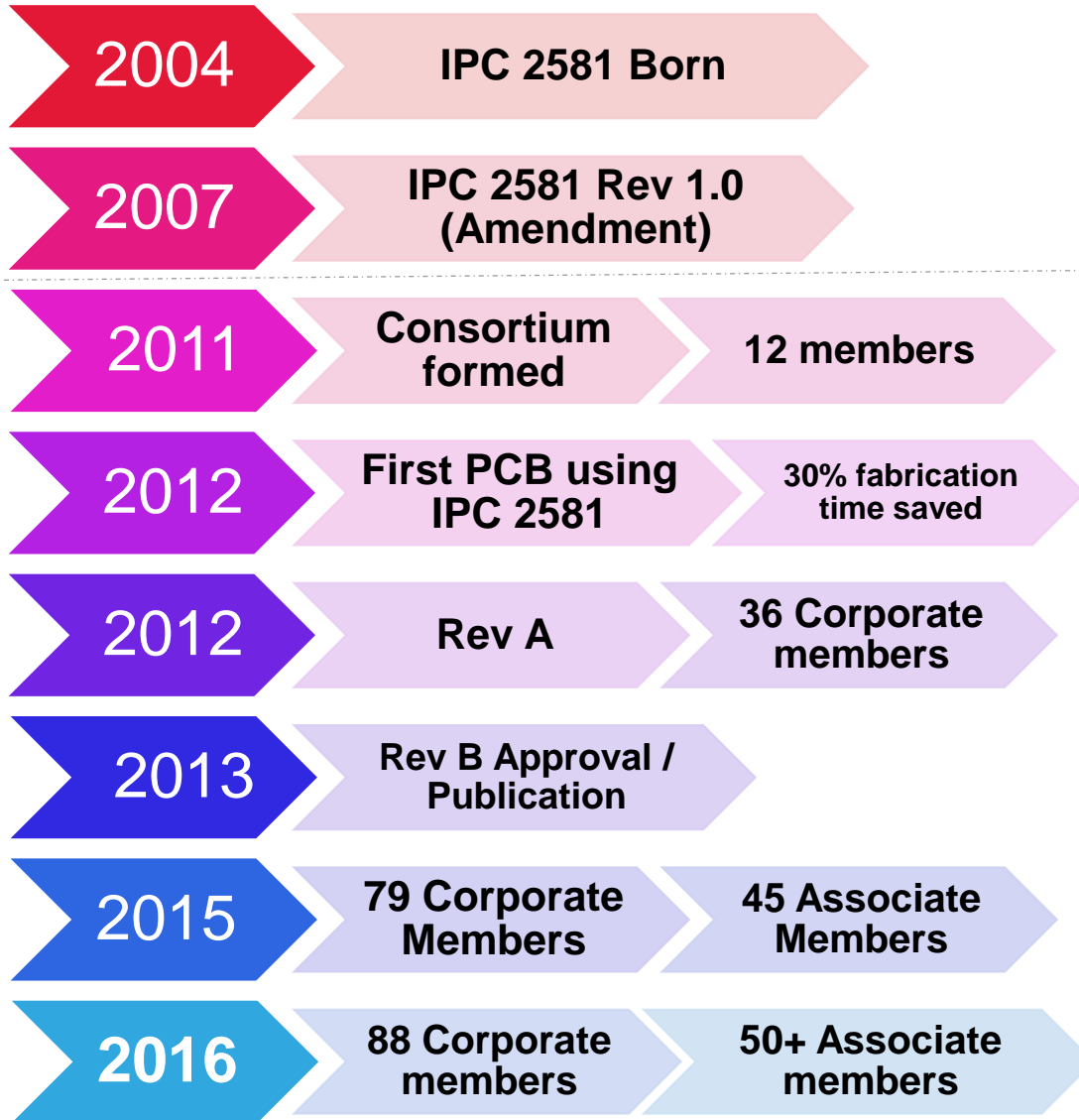
PCB West 2016, Santa Clara Convention Centre

14 Sept 2016

# Topics

1. IPC-2581 - a brief introduction
2. Adoption update
3. Standard Update
  1. Rev B1
  2. What's cooking (revC)
4. Data Augmentation

# IPC-2581 Journey



## Founding Members



# Complicated "Design to Manufacture" Today

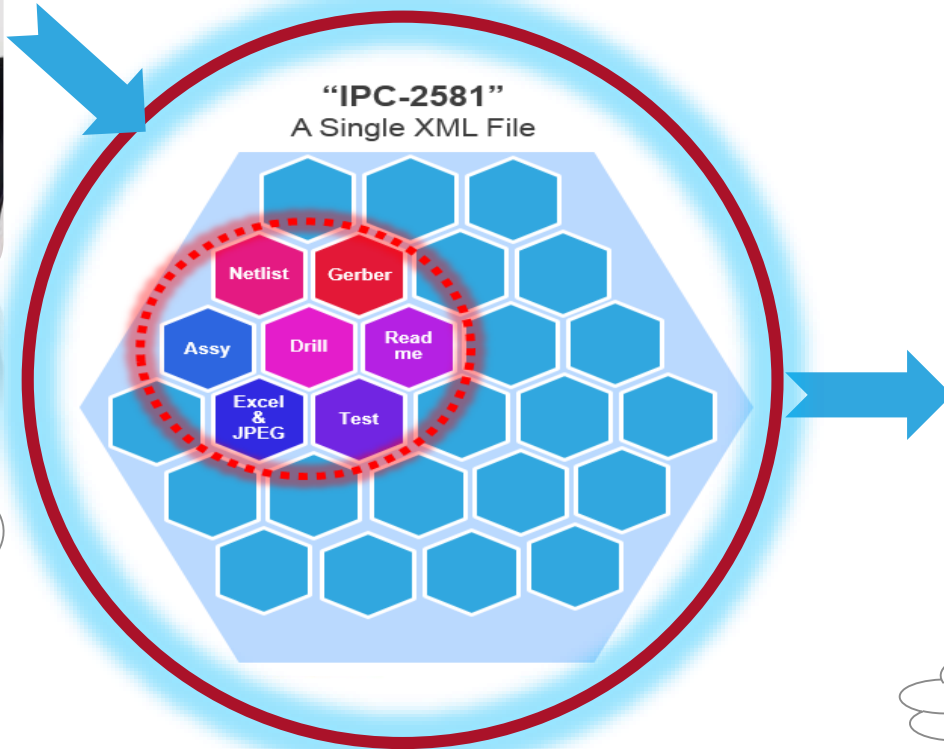
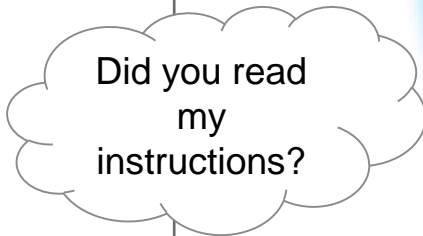
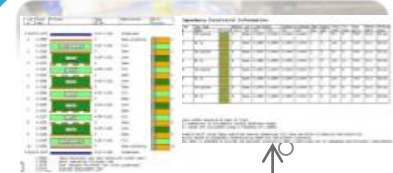
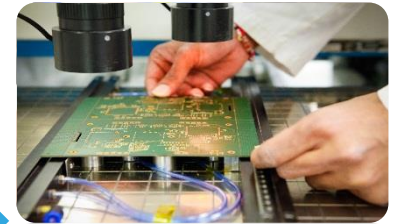
Systems Company



Intelligent, Single file  
OPEN Standard



Manufacturing Partner





A group of PCB design and supply chain companies whose goal is to enable, facilitate and drive the use of IPC-2581

Join the consortium today! Make IPC-2581 part of your company's Roadmap. Ask your suppliers to support IPC-2581

**Join Us**

For more details on how to join the consortium, please visit <http://www.ipc-2581.com/>

# IPC-2581 Consortium – [www.ipc2581.com](http://www.ipc2581.com)

## Drive innovation through collaboration

### IPC-2581 Consortium Website

- List of members
- Standard support information
- Free Viewers
- IPC-2581 Specification documents

A

### Join the Consortium

- Its Free, Join as corporate member
- 1 Click Joining Process, visit [www.ipc2581.com](http://www.ipc2581.com)

B

# IPC-2581 Industry Adoption

## Manufacturer Support Status

Company Name	Software Used	IPC-2581 Amend 1	IPC-2581A	IPC-2581B	Stack-up Exchange
<b>Accurate Circuit Engineering</b>	Genesis, InSight, InPlan		•		
<b>Axiom</b>	VisualCAM	•	•	•	•
	CircuitCAM		•	Q4 2014	
<b>CC Electronics</b>	VisualCAM	•	•	•	•
<b>Electrostein</b>	CAM350	•	•	•	
<b>Sanmina</b>	Genesis, InSight, InCAM		•		Q4 2014
<b>Sierra Circuits</b>	Genesis		•		
<b>Viasystems</b>	Genesis		•		

## Software Vendor Support Status

Company Name	Software Name	IPC-2581 Amend1	IPC-2581A	IPC-2581B	Stack-up Exchange
<b>AEGIS</b>	Factory Logix	•	•		
<b>ADIVA</b>	ADIVAnet	•	•	•	
	ADIVADPC	•	•	•	
	ADIVAvue	•	•	•	
<b>Altium</b>	Altium Designer			Q2 2016	
<b>Cadence</b>	Allegro PCB Designer	•	•	•	•
	OrCAD PCB Designer	•	•	•	
<b>Downstream Technologies</b>	CAM350		•	Q3 2015	
	Blueprint PCB		•	•	
	DFMStream		•	Q3 2015	
<b>EasyLogix</b>	PCB-Investigator	•	•		
<b>Frontline</b>	InCAM			Q3 2015	
	Insight PCB			Q3 2015	
	InStack				
<b>In-Circuit Design</b>	ICD Stackup Planner		•	•	•
<b>Numerical Innovations</b>	FAB 3000 Version		•		
	ACE 3000 Version		•		
	PreflightPCB Version		•		
<b>Polar Instruments</b>	Speedstack			•	•
<b>PTC</b>	PTC Creo View ECAD		•	Q3 2015	
<b>Siemens</b>	Test Expert		•	•	
	UniCam FX		•	•	
	UniDoc FX		•	•	
<b>Vayo</b>	VayoPro-DFM Expert		•		
	VayoPro-SMT Expert		•		
	VayoPro-Test Expert		•		
	VayoPro-Documents Expert		•		
	VayoPro-View Expert		•		
<b>WISE</b>	VisualCAM	•	•	•	•
	GerbTool	•	•	•	
	WISE2581Viewer	•	•	•	•
<b>Zuken</b>	CR-5000	•			
	CR-8000	•		•	

Support matrix on [ipc2581.com](http://ipc2581.com)

# IPC-2581 Consortium members

## PCB Design and Supply chain companies (88)

ALL



- OEMs

- Cisco, EMC, Ericsson, MSFT, Fujitsu Huawei, Network Communications, Harris, LMCO, QCOM, Qlogic, NVIDIA, Orbital, ZTE

- ECAD

- Altium, Cadence, Zuken

- DFM/CAM companies

- Frontline, Downstream, ADIVA, ....

- EMS/FAB companies

- Sanmina, Viasystems, Sierra Circuits, ...

- IPC



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# **IPC-2581** **CONSORTIUM**

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## Recent Adoption Updates

# Adoption Update

- A large networking equipment provider in Europe reported in a July 2016 consortium meeting that they have standardized on IPC-2581 since Jan 1, 2016
- The only format they provide is IPC-2581
- Successfully produced 50+ boards
- Boards are fabricated in factories located in Europe, US and China

# Adoption Update



Teledyne LeCroy has produced over **400** designs using **IPC-2581** and expects to reach over a **1000** designs this year

10 additional companies providing data to DFX Design in IPC-2581 format

# Axiom Electronics

## Contract Manufacturer

- Many of our customers are providing only IPC-2581 format to fabricate, assemble, and test their PCBs.
- Twelve of Axiom's customers have been providing IPC-2581 since 2014
- DFX Design, a subsidiary of Axiom, plans to completely automate their design handoffs to Axiom.
  - Driven by Axiom customers to provide a smoother and better transition process of their project data for full turnkey engineering projects
- PCB data in IPC-2581 format generated from **Altium**, **Cadence**, **Zuken**, and **Mentor** design tools has reduced time and streamlined customer design data hand-off to Axiom



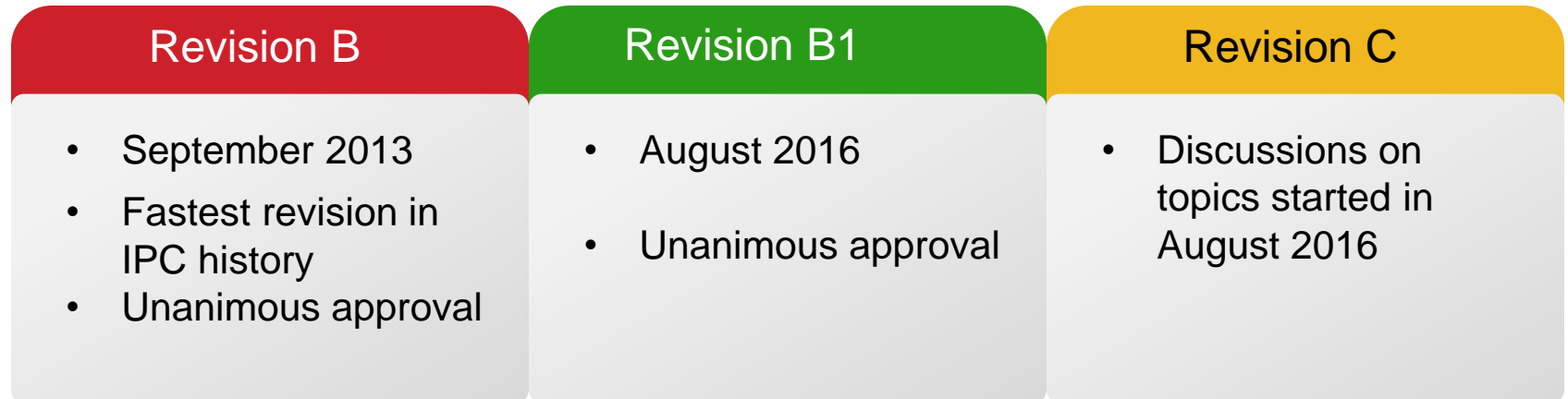
# **IPC-2581** **CONSORTIUM**

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## Standards update



# Standards Update



## CONCLUSIONS

Collaboration between Consortium members and IPC-2581/IPC  
Innovation through OPEN collaboration

# IPC-2581 Rev B Amendment1

- **Added Appendix D Summary of Changes**
  - Will be included with each rev of Spec.
  - Faster review of what's changed/added
- **Document Clarifications**
  - Reduces multiple interpretations
  - Correct missed schema detail in document
  - Address Naming types
    - Qualified NameType
    - shortName
- **Element and attribute type adjustments**
  - Object naming, such as spokeWidth vs gap
- **New Function Mode Table**
  - More function types
  - Reduces excessive data within specific functions
  - Function/mode identifiers
- **Altered data needs requirements**
  - Some element change from Required to Optional
  - Removed default value assumptions. Must be explicit.
- **More Reference types**
  - Added dielectric type (enumeration)

# Areas of improvements to be considered for revC

- **Validate Schema structure**
  - Schema structure, consistency with embedded data,. More info on Rigid-flex designs
  - BOM table enhancement with part description
- **Rigid/Flex Support**
  - Stackup structures
  - Stackup zones
  - Component placement (zone based and embedded)
- **New hole / pad types**
  - Counter sink, counter bores
- **Packaging**
  - Bond pads, wire bonds, ...
- **Enhance Variient BOM**
- **DFx – Markup, bi-directional**
- **External references to specs**



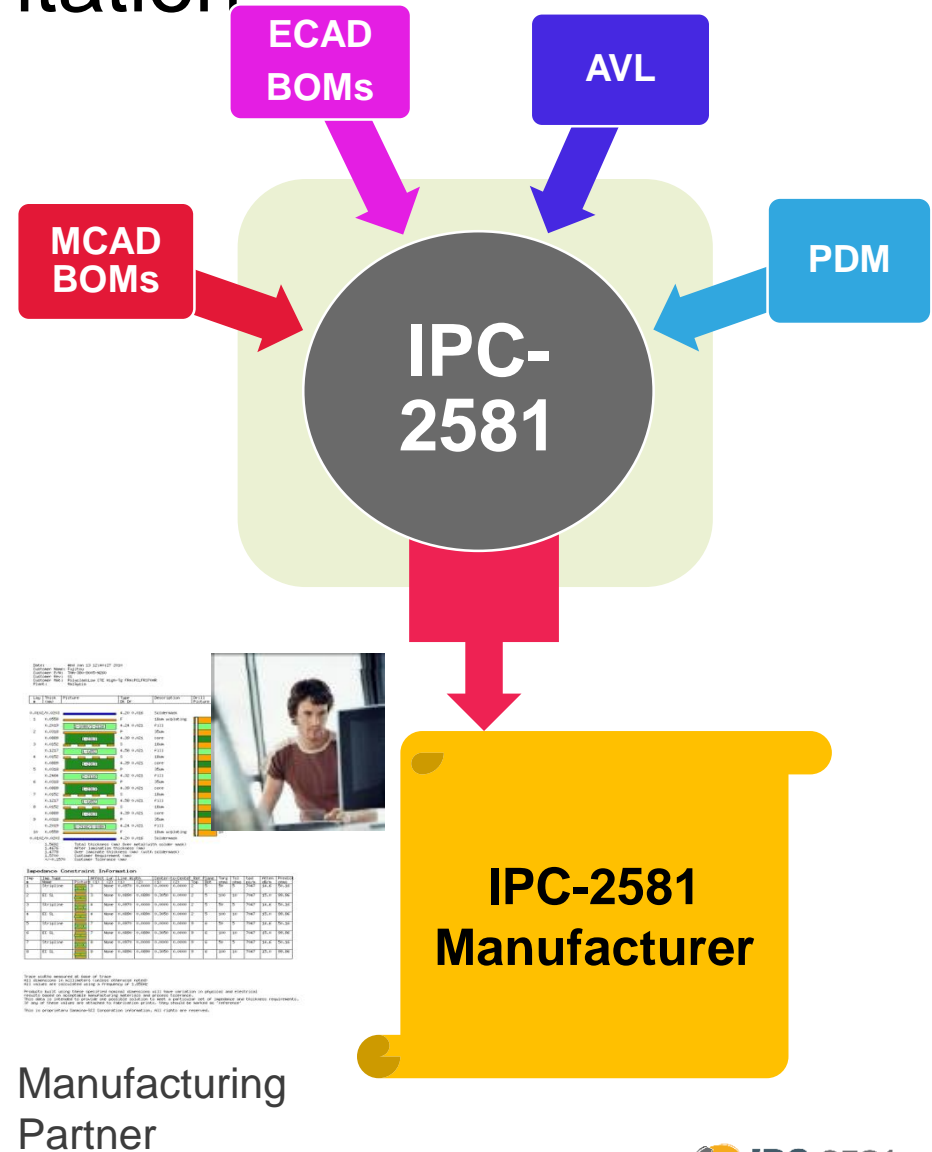
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## Data Augmentation

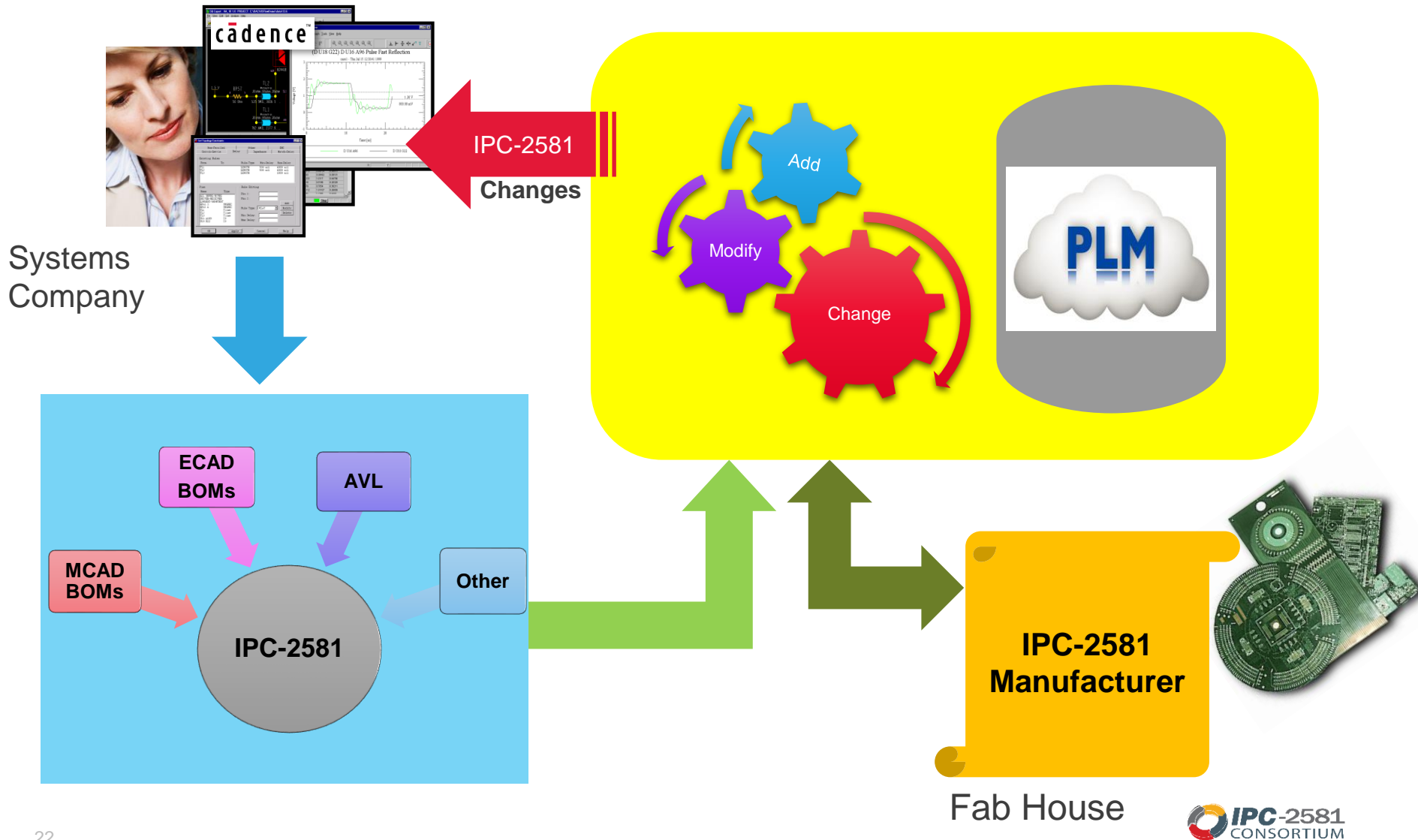
# Future direction IPC-2581 Data Augmentation

- ECAD Provides only E-BOM
- MFG needs more inputs
  - Mechanical
  - Corporate data
  - Logistic data
  - What not!
- IPC-2581 enables data augmentation very easily
- Companies can manage the IPC-2581 content as per their need
- Open Future
  - Such as “Planning Analysis”

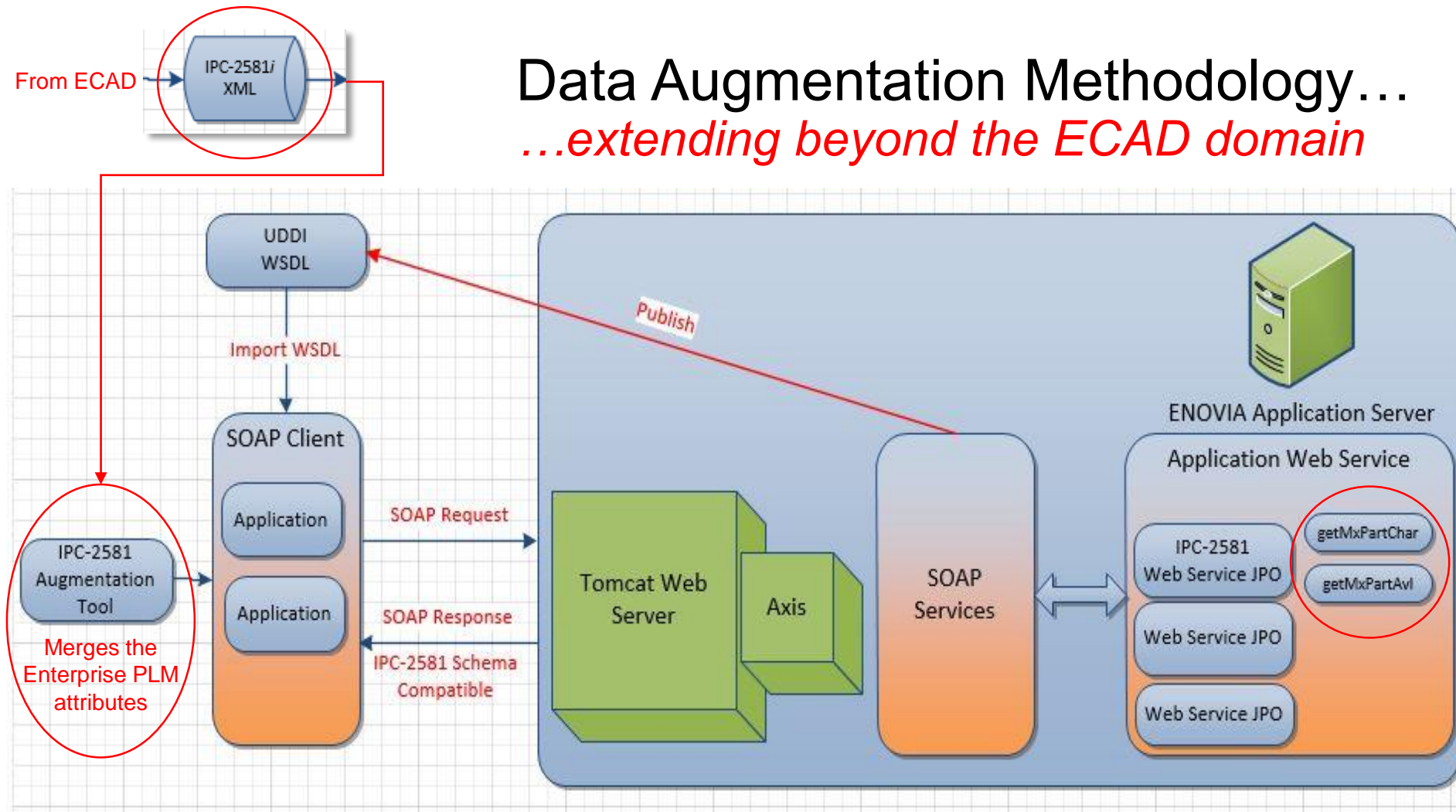


# IPC-2581 Integration with PLM

Data Augmentation made easy



# Data Augmentation Methodology... ...extending beyond the ECAD domain



*Supports the concept of the “Digital Thread”*

**Enterprise business systems can import, augment, and export IPC-2581 content in order to complete the “configuration”.**

# Data Augmentation Results

ECAD + PLM



8363 </BomItem>  
8364 <BomItem OEMDesignNumberRef="TAJ10-41CR476M" internalPartNumber="TAJ10-41CR476MAT" quantity="6" pinCount="2" category="ELECTRICAL" description="">  
8365 <RefDes name="C1571" packageRef="SC1210\_310" populate="true" layerRef="TOP"/>  
8366 <RefDes name="C1573" packageRef="SC1210\_310" populate="true" layerRef="BOTTOM"/>  
8367 <RefDes name="C1575" packageRef="SC1210\_310" populate="true" layerRef="TOP"/>  
8368 <RefDes name="C1583" packageRef="SC1210\_310" populate="true" layerRef="BOTTOM"/>  
8369 <RefDes name="C1584" packageRef="SC1210\_310" populate="true" layerRef="BOTTOM"/>  
8370 <RefDes name="C1585" packageRef="SC1210\_310" populate="true" layerRef="BOTTOM"/>  
8371 <Characteristics category="ELECTRICAL">  
8372 <Textual definitionSource="ALLEGRO" textualCharacteristicName="COMP\_CLASS" textualCharacteristicValue="DISCRETE"/>  
8373 <Textual definitionSource="ALLEGRO" textualCharacteristicName="COMP\_VALUE" textualCharacteristicValue="47UF"/>  
8374 <Textual definitionSource="ALLEGRO" textualCharacteristicName="COMP\_TOL" textualCharacteristicValue="20%/>  
8375 <Textual definitionSource="ALLEGRO" textualCharacteristicName="FNC\_VOLT" textualCharacteristicValue="16V"/>  
8376 <Textual definitionSource="ALLEGRO" textualCharacteristicName="FNC\_RANK" textualCharacteristicValue="Y"/>  
8377 <Textual definitionSource="ALLEGRO" textualCharacteristicName="HUMIDITY" textualCharacteristicValue="1"/>  
8378 <Textual definitionSource="ALLEGRO" textualCharacteristicName="LIB\_CATEGORY" textualCharacteristicValue="CAPACITOR"/>  
8379 <Measured definitionSource="ENOVIA" measuredCharacteristicName="Rated Voltage" measuredCharacteristicValue="16.0" engineeringUnitOfMeasure="V"/>  
8380 <Measured definitionSource="ENOVIA" measuredCharacteristicName="Capacitance" measuredCharacteristicValue="47.0" engineeringUnitOfMeasure="uF" engineeringNegativeTolerance="20.0" engineeringPositiveTolerance="20.0"/>  
8381 <Textual definitionSource="ENOVIA" textualCharacteristicName="SAP Material Number" textualCharacteristicValue="TAJ10-41CR476MAT"/>  
8382 <Textual definitionSource="ENOVIA" textualCharacteristicName="Classification" textualCharacteristicValue="Capacitor"/>  
8383 <Textual definitionSource="ENOVIA" textualCharacteristicName="RoHS Status" textualCharacteristicValue="06"/>  
8384 <Textual definitionSource="ENOVIA" textualCharacteristicName="FNC Rank" textualCharacteristicValue="X"/>  
8385 </Characteristics>  
8386 </BomItem>  
8387 <BomItem OEMDesignNumberRef="TAF47-W01H222K" internalPartNumber="TAF47-W01H222KAT" quantity="1" pinCount="2" category="ELECTRICAL" description="">  
8388 <RefDes name="C1617" packageRef="SC0603\_120" populate="true" layerRef="BOTTOM"/>  
8389 <Characteristics category="ELECTRICAL">  
8390 <Textual definitionSource="ALLEGRO" textualCharacteristicName="COMP\_CLASS" textualCharacteristicValue="DISCRETE"/>  
8391 <Textual definitionSource="ALLEGRO" textualCharacteristicName="COMP\_VALUE" textualCharacteristicValue="2200PF"/>  
8392 <Textual definitionSource="ALLEGRO" textualCharacteristicName="COMP\_TOL" textualCharacteristicValue="10%/>  
8393 <Textual definitionSource="ALLEGRO" textualCharacteristicName="FNC\_VOLT" textualCharacteristicValue="50V"/>  
8394 <Textual definitionSource="ALLEGRO" textualCharacteristicName="FNC\_RANK" textualCharacteristicValue="X"/>  
8395 <Textual definitionSource="ALLEGRO" textualCharacteristicName="HUMIDITY" textualCharacteristicValue="1"/>  
8396 <Textual definitionSource="ALLEGRO" textualCharacteristicName="LIB\_CATEGORY" textualCharacteristicValue="CAPACITOR"/>  
8397 <Measured definitionSource="ENOVIA" measuredCharacteristicName="Rated Voltage" measuredCharacteristicValue="50.0" engineeringUnitOfMeasure="V"/>  
8398 <Measured definitionSource="ENOVIA" measuredCharacteristicName="Capacitance" measuredCharacteristicValue="0.0022" engineeringUnitOfMeasure="uF" engineeringNegativeTolerance="10.0" engineeringPositiveTolerance="10.0"/>  
8399 <Textual definitionSource="ENOVIA" textualCharacteristicName="SAP Material Number" textualCharacteristicValue="TAF47-W01H222KAT"/>  
8400 <Textual definitionSource="ENOVIA" textualCharacteristicName="Classification" textualCharacteristicValue="Capacitor"/>  
8401 <Textual definitionSource="ENOVIA" textualCharacteristicName="RoHS Status" textualCharacteristicValue="06"/>  
8402 <Textual definitionSource="ENOVIA" textualCharacteristicName="FNC Rank" textualCharacteristicValue="Y"/>  
8403 </Characteristics>

615861 <AvlItem OEMDesignNumber="TAJ10-41CR476M">  
615862 <AvlMpn>  
615863 <AvlMpn name="GRM32ER61C476ME15L" moistureSensitivity="UNLIMITED"/>  
615864 <AvlVendor enterpriseRef="00000001347378320944"/>  
615865 <AvlVmpn>  
615866 <AvlVmpn>  
615867 <AvlMpn name="EMK325BJ476MM-T" moistureSensitivity="UNLIMITED"/>  
615868 <AvlVendor enterpriseRef="00000001347378317846"/>  
615869 <AvlVmpn>  
615870 </AvlItem>  
615871 <AvlItem OEMDesignNumber="TA46016-0003F1">  
615872 <AvlVmpn>  
615873 <AvlMpn name="PI74AVC164245AA" moistureSensitivity="UNLIMITED"/>  
615874 <AvlVendor enterpriseRef="00000001347378306799"/>  
615875 <AvlVmpn>  
615876 <AvlVmpn>  
615877 <AvlMpn name="PI74AVC164245AAE" moistureSensitivity="UNLIMITED"/>  
615878 <AvlVendor enterpriseRef="00000001347378306799"/>  
615879 <AvlVmpn>  
615880 </AvlItem>  
615881 <AvlItem OEMDesignNumber="TAF41-WB2H473K">  
615882 <AvlVmpn>  
615883 <AvlMpn name="GRM32DR72J473K0W1L" moistureSensitivity="UNLIMITED"/>  
615884 <AvlVendor enterpriseRef="00000001347378320944"/>  
615885 <AvlVmpn>  
615886 <AvlVmpn>  
615887 <AvlMpn name="C3225JB2J473K" moistureSensitivity="UNLIMITED"/>  
615888 <AvlVendor enterpriseRef="00000001347378318126"/>  
615889 <AvlVmpn>  
615890 </AvlItem>  
615891 <AvlItem OEMDesignNumber="TAA33-1B5101FX">  
615892 <AvlVmpn>  
615893 <AvlMpn name="RMC1/105101F" moistureSensitivity="UNLIMITED"/>  
615894 <AvlVendor enterpriseRef="00000001347378301072"/>  
615895 <AvlVmpn>  
615896 <AvlVmpn>  
615897 <AvlMpn name="RK73H2A5101F" moistureSensitivity="UNLIMITED"/>  
5880 <Enterprise id="00000001347378321983" name="BROADCOM CORPORATION" code="NONE"/>  
5881 <Enterprise id="00000001347378302763" name="MAXIM INTEGRATED PRODUCTS, INC." code="NONE"/>  
5882 <Enterprise id="00000001347378303230" name="MICROSEMI CORP" code="NONE"/>  
5883 <Enterprise id="00000001347378324760" name="SPECTRUM ELECTRONIC HARDWARE" code="NONE"/>  
5884 <Enterprise id="0000000134737829702" name="EPSON TOYOCOM CORPORATION" code="NONE"/>  
5885 <Enterprise id="00000001347378304115" name="NDK AMERICA INC" code="NONE"/>  
5886 <Enterprise id="00000001347378356762" name="DELTA" code="NONE"/>  
5887 <Enterprise id="00000001347378317846" name="TAIYO YUDEN CO. LTD." code="NONE"/>  
5888 <Enterprise id="00000001347378293498" name="ANALOG DEVICES INC." code="NONE"/>  
5889 <Enterprise id="0000000134737834321" name="BEL FUSE INC." code="NONE"/>

**cādence**  
Design

**ENOVIA**  
PLM

**IPC-2581 file now includes Part characteristics and AVL attributes merged from an Enterprise PLM system**



# Summary

IPC-2581 is good for PCB Design and supply companies  
Reduced cost and iterations, Improved Quality

Support a Global, Open, Neutral standard for collaboration between PCB design and manufacturing companies

Join the consortium today!  
Make IPC-2581 part of your company's roadmap  
Ask your suppliers to support IPC-2581

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